



OPTO Taiwan

The 20th Int'l Opto-electronics Exposition

SOLAR Taiwan

The 5th Int'l Solar Exposition

Exhibits

Exhibits

- 1) Compound Semiconductor
 - ◆ Materials, Ingot, Substrate, Wafer, Chip
 - ◆ Processing Equipment (Mask / Wafer / Assembly / Test)
 - ◆ Factory Facility (FA, Clean Room)
- 2) Optoelectronics Devices
 - ◆ LED, Laser Diode, EL, HBT, HEMT
 - ◆ Photo Detector, IR Sensor, CCD, CIS, CMOS
 - ◆ Display Module (LCD, OLED, LCOS, DMD)
 - ◆ Opto-Mechatronics, MEMS, Nano-technology
- 3) Optical fiber Communication
 - ◆ Active Components, Passive Components
 - ◆ Fiber, OFC System / Equipment
- 4) Laser applications
 - ◆ Lasers & Peripheral Utility, Hologram Products
 - ◆ Laser Machining, Laser Instruments, Laser Medical
- 5) Vacuum Coating
 - ◆ Target, Vacuum Equipment, Cleaner,
 - ◆ Evaporator, Sputter, LPE, MBE, CVD, etc.
- 6) Precision Instruments / Equipment
 - ◆ Optical, Electronics, Vacuum Instruments
 - ◆ Analysis, Measuring, Inspection Instrument
- 7) Precision Optics
 - ◆ Optical Lenses / Module
 - ◆ Optical Components
 - ◆ Coating Products
 - ◆ Manufacturing Equipment
 - ◆ Optical Materials

- 1) Solar integrated product and applications
 - Portable power source
 - Lighting/Traffic/Signal and Communication
 - Watch/Clock/Calculator/Toy
- 2) Photovoltaic(PV) system and installations
 - On-grid/off-grid PV systems
 - Hybrid PV systems
 - Balance of system components
 - Engineering & Installation
- 3) PV module
 - Standard, Customized
- 4) Solar cell
 - Wafer Silicon, Thin Film,
 - CPV/DSSC and organic
- 5) Materials
 - Wafer, Glass substrate, Flexible substrate
 - Paste/Lamination Materials
- 6) Production Equipment
 - Wafer(Cleaning/Processing/Measuring/Testing)
 - Cell(Cleaning/Etching/Coating/Deposition/Printing/Sorting/Testing)
 - Module assembly(Cleaning/Tabbing+Stringing/Lamination/Sorting/Testing)
- 7) PV program
 - Project developer, Financial service,
 - Consulting service



LED Lighting Taiwan

The 7th Int'l LED Lighting Exposition

Exhibits

■ LED / OLED Light Source

- 1. Epiwafer/ Chip
- 2. Epiwafer/ Chip / Package & Module
 - 2.1 Lamp 2.2 Digital 2.3 Dot Matrix 2.4 Cluster
 - 2.5 SMD 2.6 Others

■ LED / OLED Lighting Fixture

■ Technical Lighting

- 3.1.1 Exterior lights / Street lights / Tunnel lights
- 3.1.2 Architectural lights / Commercial lights
- 3.1.3 Public area lights / Solar powered lights
- 3.1.4 LED bulb / LED tube / Flashlight / Planner lights
- 3.1.5 Down light / Spotlight / Gem-Light / Stage lights
- 3.1.6 High bay lights / Mining lamps / Explosion proof lights / Exit sign lights
- 3.1.7 Plant growing lights / Dental curing lights
Surgical lights / Germicidal lamps
- 3.1.8 Others

■ 3.2 Decorative Lighting

- 3.2.1 Chandeliers / Crystal lights
- 3.2.2 Table lamps / Wall lights
- 3.2.3 Christmas lights 3.2.4 Others

■ 3.3 Accessories and Electronic Components

- 3.3.1 Lens / Heatsink
- 3.3.2 Driver / Dimmer / Transformer
- 3.3.3 Lampshades / Lamp holder
- 3.3.4 Light controller / Measurement system

3.3.5 Others

■ LED Applications

- 4.1 Backlight 4.2 Automotive Lamps
- 4.3 Display Board 4.4 Traffic Signal
- 4.5 IrDA 4.6 Others

■ LED / OLED Materials & Equipment

■ 5.1 LED Materials

- 5.1.1 Substrate 5.1.2 Ingot
- 5.1.3 Epiwafer 5.1.4 Chip
- 5.1.5 Phosphor 5.1.6 Epoxy
- 5.1.7 Lead Frame 5.1.8 Others

■ 5.2 OLED Materials

■ 6.1 LED Equipment

- 6.1.1 Crystal Growing / MOCVD
- 6.1.2 Mask / Etching / Dicing / Bonding / Packaging
- 6.1.3 Tester / Prober / Aging / Sorter 6.4 Others

■ 6.2 OLED Package / Module

www.optotaiwan.com

Photonics Festival in Taiwan:

- ◎ OPTO Taiwan ◎ SOLAR Taiwan
- ◎ LED Lighting Taiwan

Exhibit Date: June 14-16, 2011

Venue:

Taipei World Trade Center, Nangang Exhibition Hall
No.1, Jingmao 2nd Rd., Nangang District,
Taipei City 11568, Taiwan

Organizer:



Photonics Industry & Technology
Development Association

Concurrent Exposition



Display Taiwan 2011

The 13th Int'l Flat Panel Display Exposition

《How to Apply》

Application

1) Deadline of exhibit space application: **Jan. 15, 2011**

- Contact: Ms. Pamela Hsiao, PIDA
- E-mail: exhibit@mail.pida.org.tw
- Tel: 886.2.2351.4026 ext. 805
- Fax: 886.2.2396.8513

2) Exhibition Fee

Booth Classification	Booth Price	Booth Size
Raw Space	US\$2,500	3m x 3m
Package Booth	US\$2,700	3m x 3m

- **Raw Space** : Only space is offered, without partition, carpeting and any other facilities. The exhibitors should appoint a contractor to design and set up booths at their own cost.
- **Package Booth** : Standard Shell Booth is offered, including walls(2.5m H), carpeting, sign panel, 3 spotlights, 2 folding chairs, 1 reception counter, 1 socket (110V), 1 trash can.
- **Second-story Booth**: Application and extra charge will be required by the exhibition hall owner at least one month prior to the exhibition.

3) Early Payment Discount

100% Payment	Before 2010.09.30	Before 2010.11.30
Per Booth	US\$100 OFF	US\$40 OFF

4) Loyal Discount for 2009 & 2010 Exhibitors

Exhibit Year	2009	2010
Per Booth	US\$40 OFF	US\$40 OFF

Booth Assignment

1) To guarantee a space assignment, an application form with full payment of booth cost must be received for space reservation before **Jan. 15, 2011**.

2) Space assignment will be arranged in January ~ February, 2011. It is assigned according to (1) the number of booths you reserve, (2) the date of the payment received. Application without payment of the balance due will not be processed.

Payment

1) Payment by bank transfer to the account below.
(Payable in US dollars)

Bank	Mega Int'l Commercial Bank Co., Ltd., South Taipei Branch.
Name	Photonics Industry & Technology Development Association
Account No.	030-53-02182-2
Swift No.	ICBCTWTP 030

2) An invoice with payment information will be sent upon PIDA receives Application Form from the applying company.

3) Cancellation / Space Reduction

Date	Forfeit to be imposed
Before 2011.03.01(Includ)	50% of the total fee
After 2011.03.01	100% of the total fee

4) PIDA will not be responsible for any loss caused by natural disaster and irresistible enforcement.

Exhibition Hall

Taipei World Trade Center (TWTC)
Nangang Exhibition Hall

Hall	1F	4F
Ceiling Height	9M	14.3M ~ 27.3M
Floor Loading	5,000 kgs/m ²	2,000 kgs/m ²

Application & Contract for 2011 Exhibit Space

Please fill out and return to PIDA (Ms. Pamela Hsiao) by Fax: 886.2.2396.8513 or E-mail: exhibit@mail.pida.org.tw

Show to Exhibit	<input type="checkbox"/> OPTO Taiwan <input type="checkbox"/> SOLAR Taiwan <input type="checkbox"/> LED Lighting Taiwan		
Exhibitor's Name (Company name)	(In English):		
	(In Chinese):		
Contact Person	Mr. Ms.	Title :	
	E-mail :	Tel :	
	Web :	Fax :	
Office (Airmail) Address			
Number & Type of Booths Desired	<input type="checkbox"/> Package Booth : US\$2,700 per Booth ×	Booth(s)	= US\$
	<input type="checkbox"/> Raw Space : US\$2,500 per Booth ×	Booth(s)	= US\$
Company Classification	<input type="checkbox"/> 1. Manufacturer <input type="checkbox"/> 2. Distributor <input type="checkbox"/> 3. Brand / System <input type="checkbox"/> 4. Gov. / Academia / Org. <input type="checkbox"/> 5. Consultancy / VC <input type="checkbox"/> 6. Other		
Exhibit Items	1. 2. 3.		
<p>The signers of this contract warrant they are authorized to sign on behalf of the contracted company and hereby authorize PIDA to reserve exhibition space for use by this company during the Photonics Festival in Taiwan exhibitions. The undersigned acknowledges receipt of and agrees to make payments at the rates listed, abide by all terms and policies of this contract and show rules as defined in Exhibitor Service Manual.</p> <p>Signature : _____ Date : _____.</p>			

The organizers reserve the right to change the exhibit dates and place if any conditions caused by natural disaster and irresistible enforcement.

《Product Category for Exhibitor List Index on 2011 Event Directory》

Please fill in all that apply, and submit this form along with your signed application form to PIDA.

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- 2. Optoelectronics Devices: 2.1 LED 2.2 Laser Diode 2.3 HBT, HEMT 2.4 Photo Detector 2.5 IR Sensor 2.6 CCD, CIS, CMOS 2.7 Display Module 2.8 Opto-Mechatronics 2.9 MEMS 2.10 Nano-technology 2.11 Others
- 3. Optical fiber Communication (OFC): 3.1 Fiber / Cable 3.2 Active OFC Components 3.3 Passive OFC Components 3.4 OFC System / Equipment 3.5 OFC Measuring Instrument 3.6 Others
- 4. Optical Input/Output & Storage Devices:
 - 4.1 Camera 4.2 Cell Phone 4.3 OA Machines (Scanner/Fax/Printer/Copier) 4.4 Optical Drive / Player
 - 4.5 Optical Disc 4.6 Optical Engine 4.7 ODD Chip Set 4.8 Optical Drum 4.9 Pick-up Head
 - 4.10 Dye 4.11 Others
- 5. Laser applications: 5.1 Laser Machining 5.2 Medical Laser 5.3 Lab Laser 5.4 Lasers & Peripheral Utility 5.5 Hologram Products 5.6 Others
- 6. Vacuum Coating: 6.1 Target 6.2 Vacuum Equipment 6.3 Cleaner 6.4 Evaporator, Sputter, LPE, MBE, CVD 6.5 Others
- 7. Precision Instruments / Equipment: 7.1 Optical 7.2 Electronics 7.3 Vacuum Instruments 7.4 Analysis 7.5 Measuring 7.6 Inspection 7.7 Others
- 8. Precision Optics 8.1 Optical Lenses / Module 8.2 Optical Components 8.3 Coating Products 8.4 Manufacturing Equipment 8.5 Optical Materials 8.6 Others

SOLAR Taiwan

- 1. Solar cell 2. PV module 3. Photovoltaic(PV) system and Solar integrated product
- 4. Materials & Production Equipment 5. Others

LED Lighting Taiwan

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